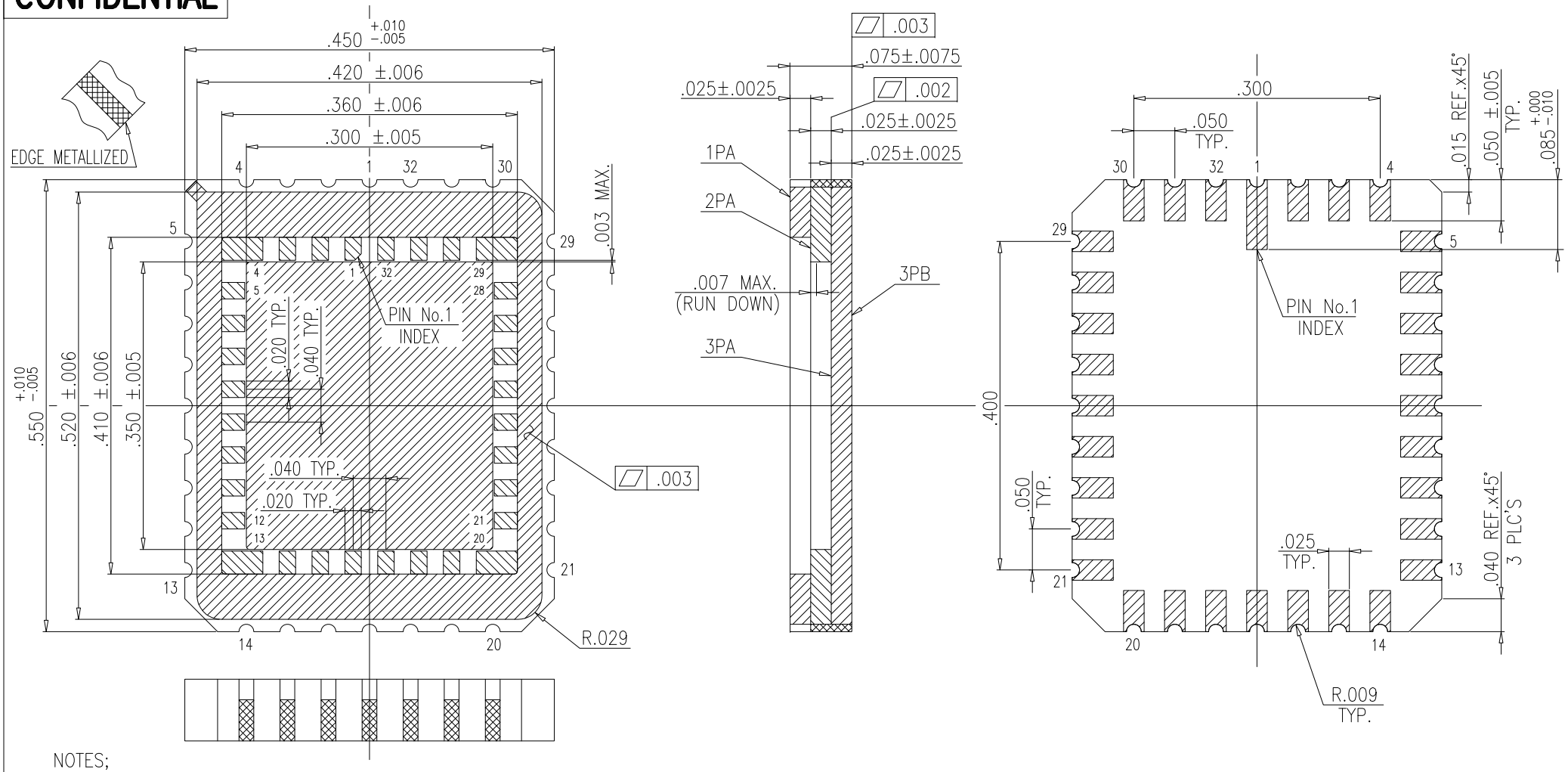
CONFIDENTIAL

UNIT:INCH



NOTES;

1. ALL EXPOSED METALLIZED AREA SHALL BE GOLD PLATED 20 MICRO INCHES MIN. THK. WITHOUT NICKEL PLATED.
2. FLATNESS PERTAINS TO METALLIZED PADS ONLY.
3. SEAL RING AREA AND DIE ATTACH AREA SHALL BE ISOLATED FROM ANY LEADS. (ZERO GROUND)
4. LEAD RESISTANCE SHALL BE 0.30 Ω MAX.
5. KYOCERA STANDARD SPEC AS-1003-B SHALL BE APPLIED EXCEPTED ITEM2(BAKING TEST). BAKING TEST SHALL BE APPLY ON BELOW.

a) BAKING TEST;
GOLD PLATING SHALL NOT SHOW BLISTERS, PEELING OR FLAKING, WHEN VIEWED BY THE NAKED EYE AFTER BAKING TEST USING HEATER BLOCK AT 350 DEGREES C FOR 1 MINUTE IN AIR ATMOSPHERE. DISCOLORATION OF GOLD PLATING SHALL BE ACCEPTABLE.

S=0
D=0

MODIFICATION										
					NAME 32 LCC (.300x.350 CAV.)	TOLERANCE UNLESS OTHERWISE SPECIFIED	DRAWN	CHECKED	APPROVED	DATE
							Yu.F	K.Hida/ H.K	K.Y	SEP.15.'15
					SCALE 6/1	MATERIAL KYOCERA A440	±.005 THIRD ANGLE PROJECTION	Yu.F	K.Hida / H.K	K.Y
	CHANGED	DATE	DRAWN	CHECKED	APPROVED	KYOCERA	KYOCERA CORPORATION KYOTO JAPAN	DRAWING NO. PB-CB5651		SHEET 1/1